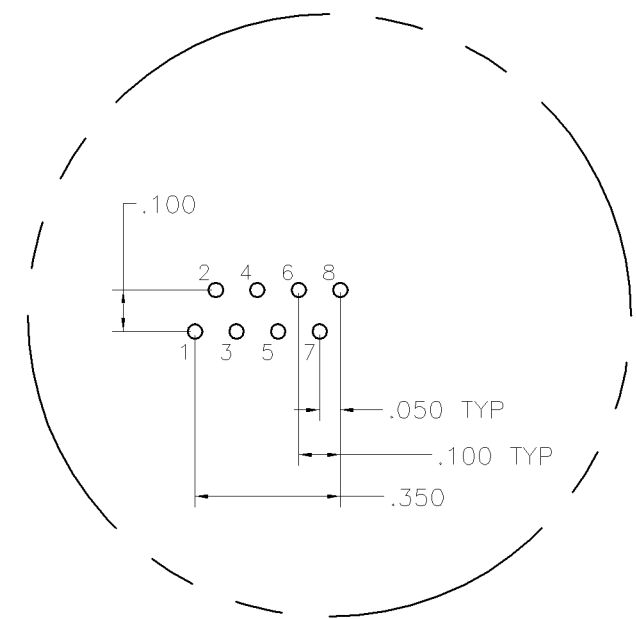
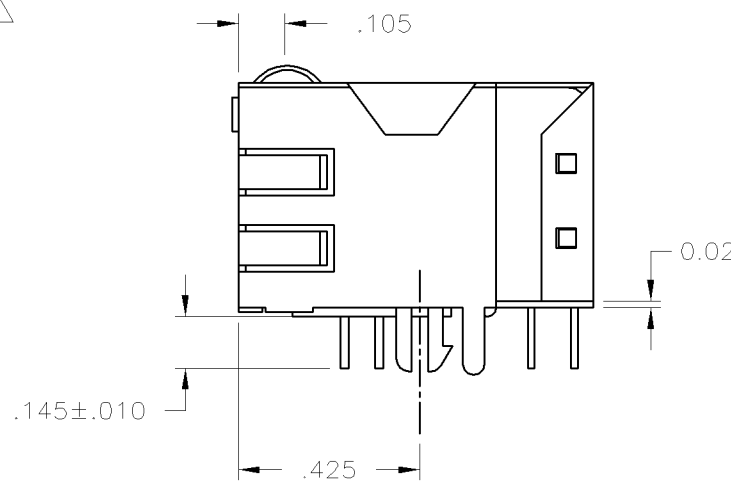
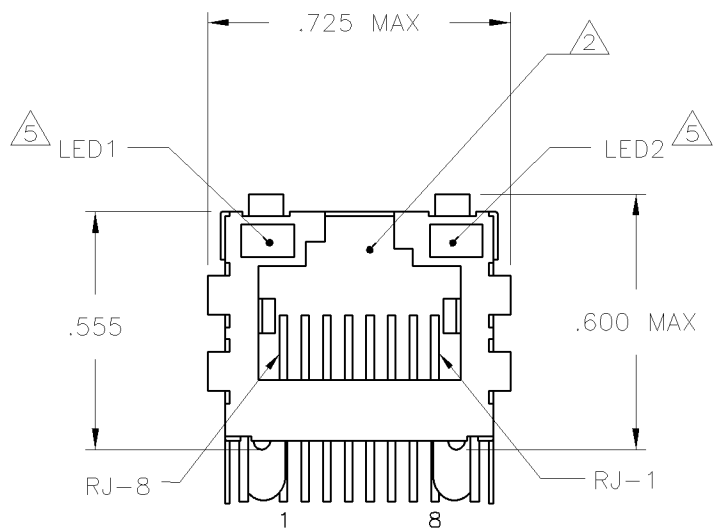
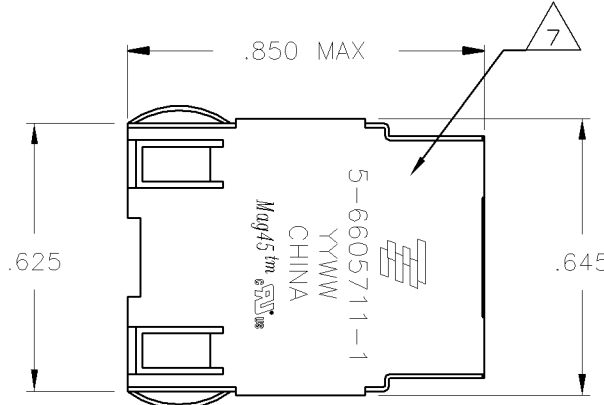


LOC		DST		REVISIONS			
AA	22	REV	PER	ECO	DATE	BY	APP
B		REV PER	ECO-08-021855		07APR2008	SX	TX

MECHANICAL:



Pin Designations

MATERIALS:
 HOUSING - THERMOPLASTIC PET POLYESTER FLAMMABILITY RATING UL 94V-0.
 SHIELD - .010" THICK, C26800 BRASS PREPLATED WITH 30μINCH MIN SEMI-BRIGHT NICKEL. SOLDER TABS POST DIPPED WITH 100μINCH MIN SAC SOLDER.
 MOD JACK CONTACTS - 0.0157 X 0.018" PHOSPHOR BRONZE, 50μINCH MIN OVERALL NICKEL UNDERPLATE WITH SELECT 50μINCH MIN HARD GOLD FINISH PLATE.
 SOLDER TAILS WITH 100μINCH MIN MATTE TIN AND/OR SAC SOLDER DIP.
 LIGHT EMITTING DIODE(LED) - DIFFUSED EPOXY LENS, .020" X .020" CARBON STEEL WIREFRAME LEADS PRE-PLATED WITH 80μINCH SILVER OVER 40μINCH NICKEL UNDERPLATE OVER 40μINCH COPPER UNDERPLATE. POST-PLATED WITH 100μINCH MIN MATTE TIN AND/OR SAC SOLDER DIP OR PURE TIN SOLDER DIP.

MAGNETICS
 -IMPEDANCE: 100 OHMS
 -TURNS RATIO (CHIP:CABLE): TX = 1:1, RX = 1:1
 -OPEN CIRCUIT INDUCTANCE (OCL): 350μH MIN @100kHz, 0.1VRMS, 8mA DC BIAS FROM -40°C TO +85°C, TX AND RX
 -PERFORMANCE @ 25°C:
 INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz
 RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 30MHz
 18-20LOG(f/30)dB MIN FROM 30.1MHz TO 60MHz
 12dB MIN FROM 60.1MHz TO 80MHz
 CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz
 33-20xLOG(f/50)dB MIN FROM 40.1MHz TO 100MHz
 COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz
 -ISOLATION VOLTAGE: COMPLIES WITH IEEE802.3 2002, PARA 23.5.1.1, ITEM b.

4. OPERATING TEMPERATURE: FROM -40° - +85°C.

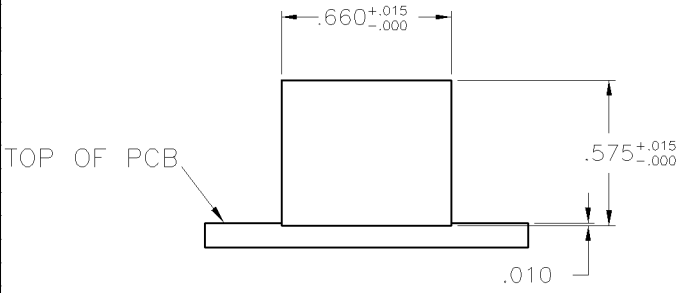
LED WITH 250 OHM RESISTORS, LED IS DRIVEN WITH 5V VOLTAGE AND THE MAX OPERATING CURRENT IS 20mA.
 LED COLOR : DOMINANT WAVELENGTH (λD): GREEN 568 nm TYP. At VF=5V
 FORWARD CURRENT (IF): GREEN 12 mA TYP. at VF=5V
 DOMINANT WAVELENGTH (λD): YELLOW 588 nm TYP. At VF=5V
 FORWARD CURRENT (IF): YELLOW 13 mA TYP. at VF=5V

INDICATED CONNECTIONS ARE FOR NIC CONFIGURATION. THE MAGNETICS ARE ASYMMETRICAL, AND THEREFORE ARE NOT AUTO-MDI/MDIX CAPABLE.

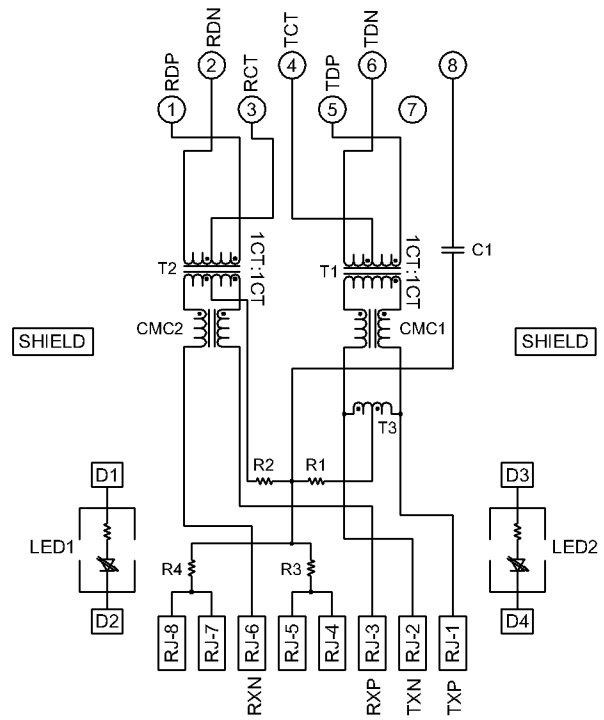
TYCO ELECTRONICS LOGO, PART NUMBER, DATE CODE, COUNTRY OF ORIGIN AND AGENCY APPROVAL MARKING IN APPROXIMATE LOCATION SHOWN.

8. THESE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PREHEAT TEMPERATURE IS 120°C TO 160°C, 120 SECONDS TO 180 SECONDS, PEAK WAVE SOLDERING TEMPERATURE IS 260°C MAX, 10 SECONDS MAX.

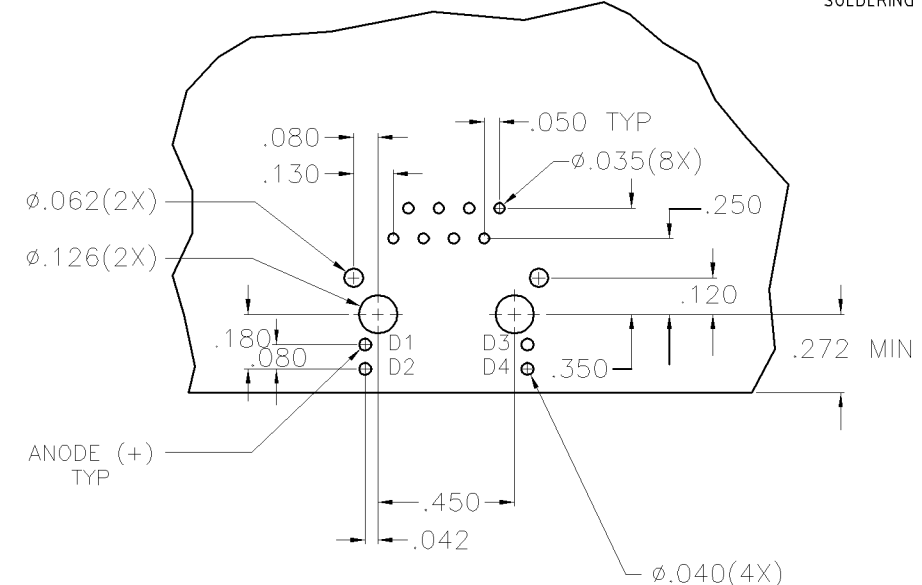
714ET SERIES MAGNETIC SCHEMATIC



Suggested Panel Cutout



C1=1000pF. 2kV DECOUPLING CAPACITOR
 R1-R4 = 75 OHMS, 1/16 W RESISTORS



Suggested PCB Layout (Component Side)

YES	GREEN	YELLOW	5-6605711-1
NO	GREEN	YELLOW	6605711-1
2kV DECOUPLING CAPACITOR	LED1	LED2	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		REV: G. ATTADIA - DOCKS	DATE: 10MAR05	BY: Tyco Electronics Corporation
DIMENSIONS: INCHES		DESIGNER: D. FAROLE	DATE: 10MAR05	NAME: Tyco Electronics ChangPing, China
TOLERANCES UNLESS OTHERWISE SPECIFIED:		PRODUCT SPEC: 1X1 MAG45(TM) MODULAR JACK, 7N2ET INDUSTRIAL TEMP SCHEMATIC, 714 SERIES CIRCUIT, SHIELDED, DECOUPLING CAPACITOR, WITH RESISTOR LEADS		
0 PLG ± -	1 PLG ± .010	APPLICATION SPEC: 108-2100	SIZE: A1	DATE CODE: 00779
2 PLG ± .010	3 PLG ± .005	RESTRICTED TO: -	SCALE: NTS	SHEET: 1 OF 1
4 PLG ± -	ANGLES ± -	CUSTOMER DRAWING	REV: B	